mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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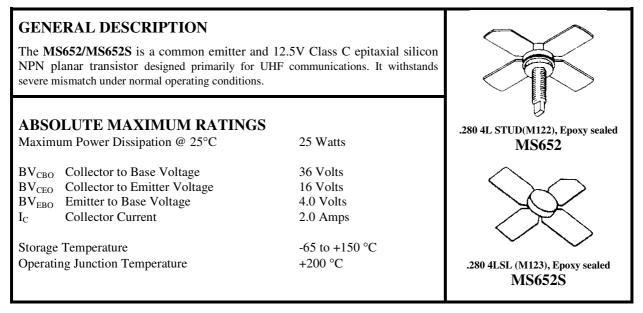
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





MS652/MS652S

5.0 Watts, 12.5 Volts, Class C UHF Applications



FUNCTIONAL CHARACTERISTICS @ 25°C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
P _{OUT}	Power Out	F = 512 MHz	5.0	-	-	W
P _{IN}	Power Input	$V_{CE} = 12.5V$	-	-	0.5	W
G _P	Power Gain	$V_{CE} = 12.5 V$	10.0	-	-	dB
η	Efficiency	$P_{OUT} = 5W$	60	-	-	%

ELECTRICAL CHARACTERISTICS @ 25°C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
BV _{CES}	Collector to Emitter Breakdown	$I_{\rm C} = 25 \text{ mA}, V_{\rm BE} = 0$	36	-	-	V
BV _{CEO}	Collector to Emitter Breakdown	$I_{\rm C} = 50 \text{ mA}, I_{\rm B} = 0$	16	-	-	V
BV _{CBO}	Collector to Base Breakdown	$I_{\rm C} = 25 \text{ mA}, I_{\rm E} = 0$	36	-	-	V
BV _{EBO}	Emitter to Base Breakdown	$I_{\rm E} = 5 \text{ mA}, I_{\rm C} = 0$	4.0	-	-	V
I _{CES}	Collector to Emitter Leakage	$V_{CE} = 15 \text{ V}, V_{BE} = 0$	-	-	1.0	mA
\mathbf{h}_{FE}	DC – Current Gain	$I_{C} = 200 \text{ mA}, V_{CE} = 5 \text{ V}$	10	-	150	-
C _{OB}	Output Capacitance	$F = 1MHz$, $V_{CB} = 15V$	-	-	15	pF
θjc ¹	Junction-Case Thermal Resistance		-	-	7	°C/W

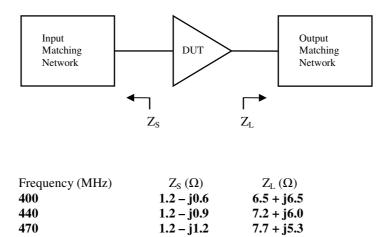
NOTES: 1. At rated output power with MSC fixture. Rev. A: May. 2010

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MS652/MS652S

Typical Impedance Values



1.2 – j1.5

8.3 + j4.5

* $V_{CC} = 12.5 V$, $P_{OUT} = 5 W$

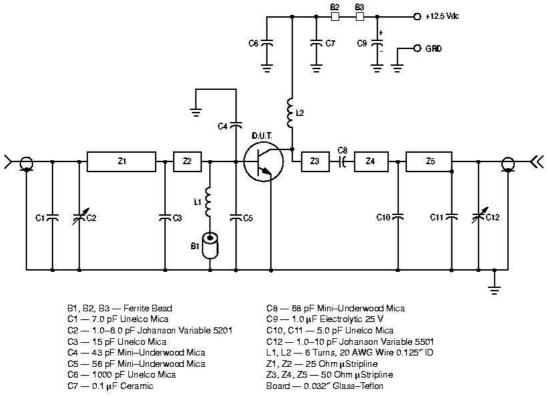
512

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440 - 512 MHz Broadband Test Circuit



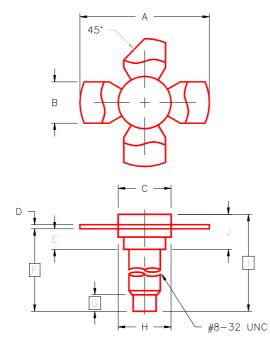
 $\begin{array}{l} C8 & = 68 \ \text{pF Mini-Underwood Mica} \\ C9 & = 1.0 \ \mu\text{F Electrolytic } 25 \ \text{V} \\ C10, C11 & = 5.0 \ \text{pF Unelco Mica} \\ C12 & = 1.0 - 10 \ \text{pF Johanson Variable } 5501 \\ L1, L2 & = 6 \ \text{Turns}, 20 \ \text{AWG Wire } 0.125^{\prime\prime\prime} \ \text{ID} \\ Z1, Z2 & = 25 \ \text{Ohm} \ \mu\text{Stripline} \\ Z3, Z4, Z5 & = 50 \ \text{Ohm} \ \mu\text{Stripline} \\ \text{Board} & = 0.032^{\prime\prime\prime} \ \text{Glass-Teflon} \end{array}$

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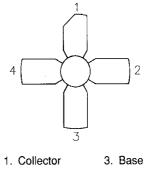
MS652/MS652S

PACKAGE STYLE M122



	MINIMUM INCHES/MM	MAXIMUM INCHES/MM		MINIMUM INCHES/MM	MAXIMUM INCHES/MM
А	1.010/25,65	1.055/26,80		.640/16,26	
В	.220/5,59	.230/5,84	J	.175/4,45	.217/5,51
С	.270/6,86	.285/7,24			
D	.003/0,08	.007/0,18			
Е	.117/2,97	.137/3,48			
F	.572/14,53				
G	.130/3,30				
Н	.275/6,99	.285/7,24			

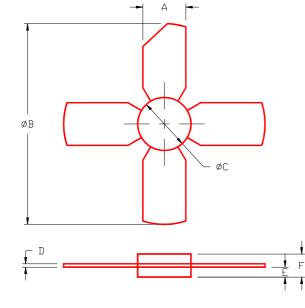
PIN CONNECTION



2. Emitter 4. Emitter

		MINIMUM	MAXIMUM	Τ	MINIMUM	MAXIMUM
		INCHES/MM	INCHES/MM		INCHES/MM	INCHES/MM
6	4	.220/5,59	.230/5,84			
]	В		1.055/26,8	Τ		
(()	.275/6,99	.285/7,24			
]	D	.004/0,10	.006/0,15			
E	1.1	.050/1,27	.060/1,52			
F		.118/3,00	.130/3,30			

PACKAGE STYLE M123



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